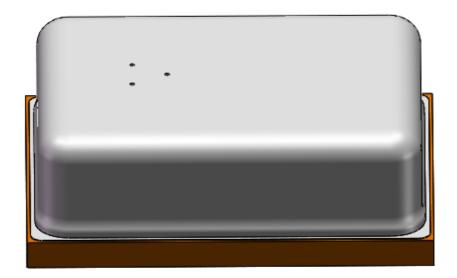
SV01-003 Bone Sensor

Product Datasheet



Restricted

1. Security warning

The information contained in this document is the exclusive property of Goermicro Inc. and should not be disclosed to any third party without the written consent of Goermicro Inc..

2. Publication history

Version	Date	Description
1.0	2021.08.31	Preliminary datasheet
1.1	2021.09.23	Update tape depth in package specifications
2.0	2021.10.21	Update response curve and mark configuration
3.0	2021.12.23	Update response curve



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1. Introduction

The SV01-003 is a high performance Bone sensor optimized for picking-up people's voice through bone vibration, which achieves a better signal with high SNR and shields the normal ambient sound noise.

Key features

Package: 6-pin LGA package, 3.5mm x 2.65mm x 1.30mm

Pb-free, halogen-free and RoHS compliant

Performance

Supply voltage: 1.52 ... 1.89V (low power mode)

Low Current: 50 μA

High sensitivity: -25 +3/-2 dBv/g
 Low Noise: Noise Density ≤2ug/√Hz

Reflow Solderable

Applications

- Wearable/hearable devices
- Communication in noisy/challenging types of environments
- Hearing aids
- Bone Joint Monitor in health prediction field
- Mechanical Joint Monitor and device conditioning
- Structure Health Monitor

2. Absolute Maximum Ratings

Table 1: Absolute Maximum Ratings

Parameters		Condition	Min	Max	Unit
	Storage Temperature		-40	+85	°C
	Supply Voltage	All Pins	-0.3	+3.6	V
	ESD rating	HBM,R=1.5kohm,C=100pF		±2	kV
	Maximum Acceleration	in Z Direction		10000	g



3. Testing Conditions

Table 2: Testing Condition (Vent Hole Sealed)

Test Conditions	Temperature	Humidity	Air Pressure
Standard Conditions	+15~+35℃	25%RH~75%RH	860hPa~1060hPa
Judgment Conditions	+20±2℃	40%RH~50%RH	860hPa~1060hPa

4. Characteristics

Table 3: Parameter List

Parameters	Symbol	Condition	Min	Typical	Max	Unit
Power Supply						,
Supply Voltage	V-1-1	Low Power Mode	1.52	1.8	1.89	V
Supply Voltage Vdd		Normal Mode	2.3		3.0	V
Current	IDD	1.52V≤VDD≤1.89V		50	100	uA
	טטו	2.3V≤VDD≤3.0V		150	200	uA
Output Impedance	Zout			150	400	Ω
Performance						
		f=100Hz, Z Axis, re.1kHz value	-8	-5	-2	dBV/g
Sensitivity	S	f=1000Hz, Z Axis	-27	-25	-22	dBV/g
		f=2000Hz, Z Axis, re.1kHz value	-1	2	5	dBV/g
Acoustic Sensitivity Loss	@100Hz	Sensitivity loss to ambient	40	50		dB
	@1kHz	acoustic signals	30	40		dB
Acceleration Level		<10% THD@1kHz		±4		g
Low Power Mode					•	
		BW=100~4000Hz, A-		101		dD.
Equivalent Noise		weighted1/3 octave		-101		dBv
Noise Density	@250Hz				6	ug/√Hz
	@1kHz				3	ug/√Hz
	@2kHz				2	ug/√Hz
Normal Mode						
Equivalent Noise		BW=100~4000Hz, A-	-102			dBv
Lyuivaieni Noise		weighted1/3 octave				ubv
	@250Hz				6	ug/√Hz
Noise Density	@1kHz				3	ug/√Hz
	@2kHz				2	ug/√Hz



Response Curve:

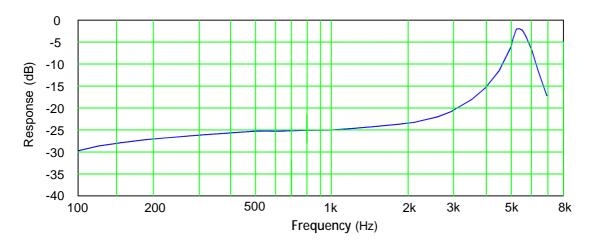


Figure 1: Frequency Response Curve

5. Mechanical Parameters

5.1 Pin Configuration

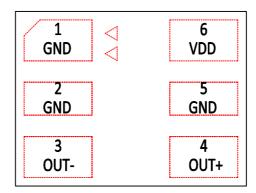


Figure 2: Layout pin configuration SV01-003 (Top View, PAD not visible)

Table 4: SV01-003 Pin Configuration

Pin	Name	Function	
1	GND	Ground	
2	GND	Ground	
3	OUT-	Signal Output	
4	OUT+	Signal Output	
5	GND	Ground	
6	VDD	Power Supply	



5.2 Outline Dimensions

The sensor housing is a 6 Pin LGA package with metal lid. Its dimensions are 3.5mm (±0.1 mm) x 2.65mm (±0.1 mm) x1.3mm (±0.1mm). Tolerance is ±0.1mm unless otherwise specified.

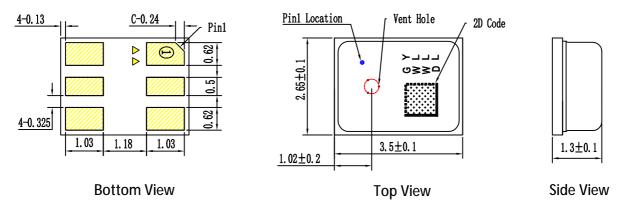


Figure 3: SV01-003 outline and size

6. Storage and Transportation

Keep in warehouse with less than 75% humidity and without sudden temperature change, acid air, any other harmful air or strong magnetic field.

The sensor with normal pack can be transported by ordinary conveyances. Please protect products against moist, shock, sunburn and pressure during transportation.

Storage Temperature Range: $-40^{\circ}\text{C} \sim +85^{\circ}\text{C}$ Operating Temperature Range: $-30^{\circ}\text{C} \sim +70^{\circ}\text{C}$

7. Cautions

Vent Hole Protection

During reflow welding, it is forbidden to seal the vent holes of the sensor, to let air flow through vent holes in high temperature and avoid high air expansion damaging the package and the sensor.

After reflow process, it is recommended to seal the vent holes with Mylar membrane or UV glue, to prevent particle and enhance acoustic sensitivity loss.

After vent holes sealed, it is not recommended to handle the sensor in high temperature (more than 100°), to avoid air expansion and damage to sensor and its performance.

Nozzle Application

During SMT process, pay attention to avoid picking vent holes area, otherwise this may cause the device damage.

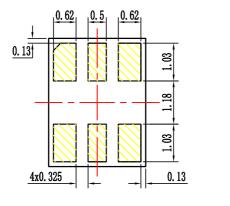
Others

It is forbidden to wash the device with liquid before sealed hole, such as water, alcohol etc., otherwise this could damage the device.



8. PCB Design and Reflow Soldering

Land Pattern Recommendation



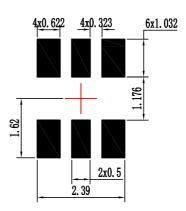


Figure 4: PCB Layout Pattern (Left), Solder Paste Stencil Pattern (Right)

Nozzle and Picking Area

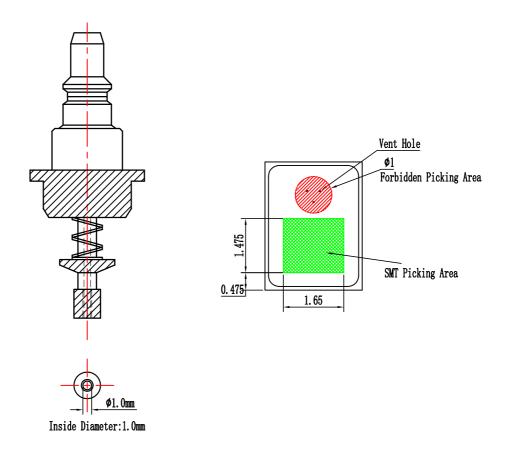


Figure 5: SMT Nozzle Dimension (Left), Picking Area Drawing (Right)

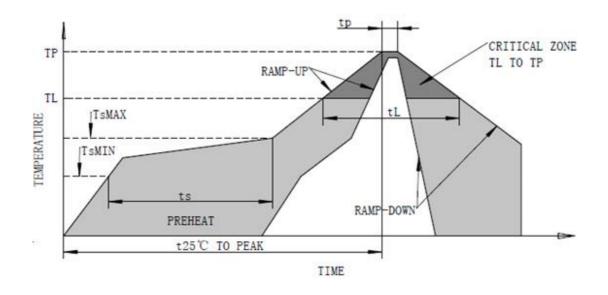


Soldering Recommendation

Soldering Machine Condition

Temperature Control	8 zones
Heater Type	Hot Air
Solder Type	Lead-free

Soldering Profile

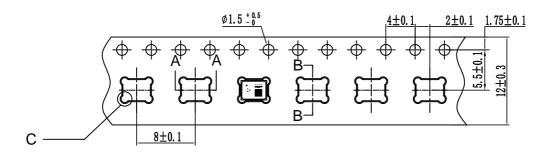


Profile Feature	Pb-Free Assembly	
Average ramp-up rate(TsMAX to TP)	2.5℃/seconds max.	
Preheat -Temperature Min.(TsMIN) -Temperature Max.(TsMAX) -Time(TsMIN to TsMAX)(Ts)	150℃ 200℃ 120~180 seconds	
Time maintained above: -Temperature(TL) -Time(tL)	217°C Max 80 seconds	
Peak temperature(TP)	260℃	
Time within 5°C of actual peak temperature(TP)2	Max 50 seconds	
Ramp-down rate	-5℃/seconds max.	
Time 25℃ to peak temperature	8 minutes max.	

9. Package Specifications

9.1 Tape Specifications

Quantity per reel: 4000pcs.



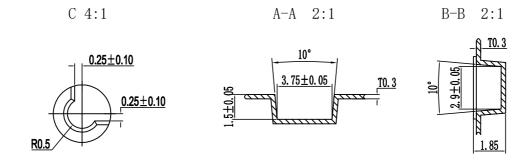


Figure 6: Tape Information (Unit: mm)

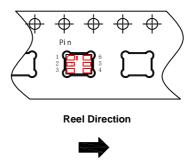


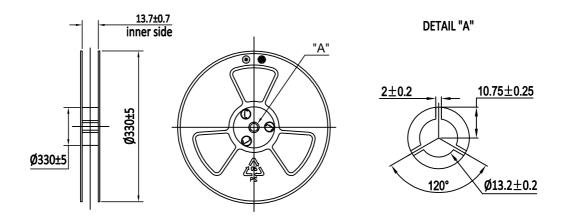
Figure 7: Pin Information



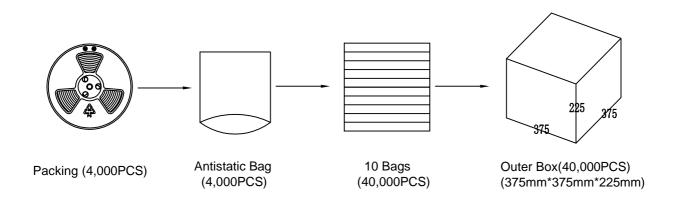
9.2 Reel Specification

13" reel will be provided for mass production stage and sample stage more than 1000pcs

13" Reel Specification (Unit: mm)



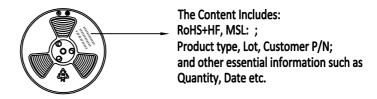
9.3 The content of Box





9.4 Packing Explain

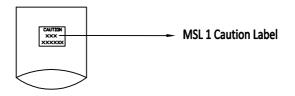
The Label Content of the Reel



The Label Content of ESD Caution



The Label Content of Moisture Caution



单击下面可查看定价,库存,交付和生命周期等信息

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